

Serial Number 	Application No.	Applicant(s)
	10/678,513	JUENGLING

TERMINAL DISCLAIMER		<input checked="" type="checkbox"/> APPROVED	<input type="checkbox"/> DISAPPROVED
The term of this patent shall not extend beyond the expiration date of U.S. Patent No:	6.395,623		
The term of this patent subsequent to the adjacent date has been disclaimed.			
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/678,513
Filing Date October 3, 2003
Inventor Werner Juengling
Assignee Micron Technology, Inc.
Group Art Unit..... 2823
Examiner Brook Kebede
Attorney's Docket No. MI22-2391
Title: Semiconductor Processing Methods of Forming a Contact Opening to a
Conductive Line and Methods of Forming Substrate Active Area
Source/Drain Regions

TERMINAL DISCLAIMER

I, D. Brent Kenady, residing at Spokane, Washington, represent that I am the attorney of record for Micron Technology, Inc., a corporation of the state of Delaware. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/678,513, filed October 3, 2003, as evidenced by an assignment recorded August 27, 1998, at Reel 9416, Frames 0220-0225 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all right, title and interest in U.S. Patent No. 6,395,623 as evidenced by an assignment recorded August 27, 1998, at Reel 9416, Frames 0220-0225, in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all right, title and interest in U.S. Patent No. 6,635,558 as evidenced by an assignment recorded August 27, 1998, at Reel 9416, Frames 0220-0225, in the U.S. Patent and Trademark Office.

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The evidentiary documents have been reviewed, and I certify that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/678,513 which extends beyond the expiration date of U.S. Patent Nos. 6,395,623 and 6,635,558, and further hereby agrees that any future patent so granted on this U.S. Patent Application Serial No. 10/678,513 shall be enforceable only for and during such period that the legal title on U.S. Patent Nos. 6,395,623 and 6,635,558 shall be the same as the legal title to any patent issued from U.S. Patent Application Serial No. 10/678,513. This agreement is to run with any patent granted on the 10/678,513 application and is to be binding upon the grantee of such patent and its successors or assigns.

Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/678,513 application prior to the expiration date of the full statutory terms of the United States Patent Nos. 6,395,623 and 6,635,558 in the event that they later expire for failure to pay a maintenance fee, are held unenforceable, are found invalid by a court of competent jurisdiction, are statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. §1.321(a), have all claims canceled by a reexamination certificate, are reissued in any manner or are otherwise terminated prior to expiration of its full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, D. Brent Kenady, hereby indicates that he is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Dated: 1-18-05

By: 

D. Brent Kenady

Reg. No. 40,045